

Maximum Ratings @TA = 25°C unless otherwise specified

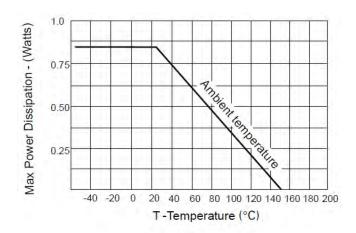
| Characteristic | Symbol | Value | Unit |
|------------------------------------|------------------|-------|------|
| Drain-Source Voltage | V_{DSS} | 60 | V |
| Gate-Source Voltage | V _{GSS} | ±20 | V |
| Continuous Drain Current | I _D | 1.1 | Α |
| Practical Continuous Drain Current | I _{DP} | 1.3 | А |
| Pulsed Drain Current | I _{DM} | 15 | Α |

Thermal Characteristics @TA = 25°C unless otherwise specified

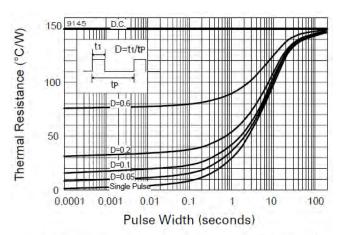
| Characteristic | | Symbol | Value | Unit |
|-----------------------------------------|----------|-----------------------------------|-------------|------|
| Power Dissipation | | P _D | 850 | mW |
| Practical Power Dissipation | (Note 2) | P _{DP} | 1.13 | W |
| Thermal Resistance, Junction to Ambient | | $R_{\theta JA}$ | 150 | °C/W |
| Thermal Resistance, Junction to Ambient | (Note 2) | R _{θJA} | 111 | °C/W |
| Thermal Resistance, Junction to Leads | (Note 3) | $R_{	heta JL}$ | 50 | °C/W |
| Operating and Storage Temperature Range | | T _J , T _{STG} | -55 to +150 | °C |

Notes:

^{3.} Thermal resistance from junction to solder-point



Derating curve



Maximum transient thermal impedance

^{2.} For a device mounted on 25mm X 25mm X 1.6mm FR-4 PCB with high coverage of single sided 1oz copper, in still air condition.



Electrical Characteristics @T_A = 25°C unless otherwise specified

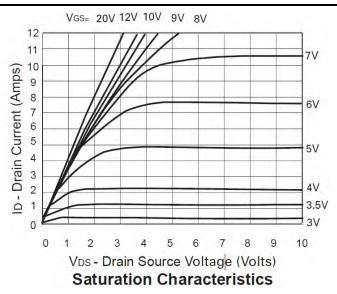
| Characteristic | Symbol | Min | Тур | Max | Unit | Test Condition |
|-------------------------------------------------------|----------------------|-----|--------------|--------------|------|--------------------------------------------------------------------------------------------------------------------|
| OFF CHARACTERISTICS (Note 4) | | | | | | |
| Drain-Source Breakdown Voltage | BV _{DSS} | 60 | - | - | V | $V_{GS} = 0V$, $I_D = 1mA$ |
| Zero Gate Voltage Drain Current T _J = 25°C | I _{DSS} | - | - | 1 20 | μΑ | V _{DS} = 60V, V _{GS} = 0V V _{DS} = 48V, V _{GS} = 0V, T _A = 125°C |
| Gate-Source Leakage | I _{GSS} | - | - | ±100 | nA | $V_{GS} = \pm 20V, V_{DS} = 0V$ |
| On-State Drain Current | I _{D(on)} | 12 | - | - | Α | V _{GS} = 10V, V _{DS} = 10V |
| ON CHARACTERISTICS (Note 4) | | | | | | |
| Gate Threshold Voltage | $V_{GS(th)}$ | 1.3 | - | 3 | V | $V_{DS} = V_{GS}$, $I_D = 1mA$ |
| Static Drain-Source On-Resistance | R _{DS (on)} | - | 0.22 0.32 | 0.33 0.45 | Ω | $V_{GS} = 10V, I_D = 3A$ $V_{GS} = 5V, I_D = 1.5A$ |
| Forward Transconductance | 9 _{fs} | 700 | - | - | mS | $V_{DS} = 10V, I_{D} = 3A$ |
| DYNAMIC CHARACTERISTICS (Note 4) | - | • | | • | | |
| Input Capacitance | C _{iss} | - | - | 350 | pF | V 05V V 0V |
| Output Capacitance | Coss | - | - | 140 | pF | $V_{DS} = 25V, V_{GS} = 0V,$ f = 1.0MHz |
| Reverse Transfer Capacitance | C _{rss} | - | - | 30 | pF | |
| Turn-On Delay Time (Note 5) | t _{d(on)} | - | - | 8 | ns | |
| Turn-On Rise Time (Note 5) | t _r | - | - | 25 | ns |), or, , , , , , , , , , , , , , , , , , |
| Turn-Off Delay Time (Note 5) | t _{d(off)} | - | - | 30 | ns | $V_{DD} = 25V, I_D = 3A, V_{GEM} = 10V$ |
| Turn-Off Fall Time (Note 5) | t _f | - | - | 16 | ns | |

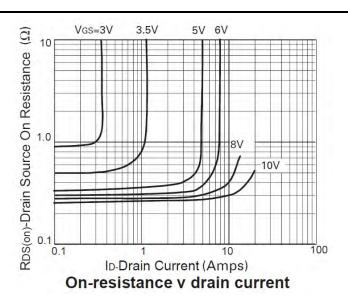
Notes:

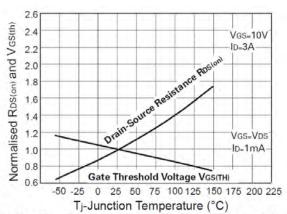
^{4.} Measured under pulsed conditions. Width = $300\mu s$. Duty cycle $\leq 2\%$ 5. Switching times measured with 50Ω source impedance and <5ns rise time on a pulse generator

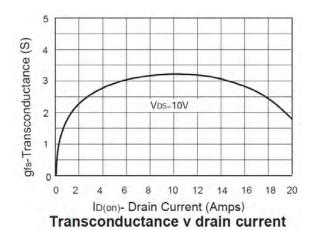


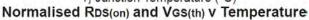
Electrical Characteristics

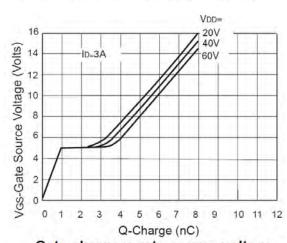


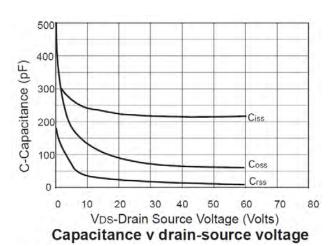








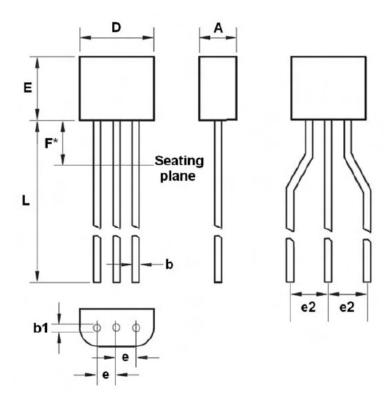




Gate charge v gate-source voltage



Package Outline Dimensions



| DIM | Millimeters | | Inches | | |
|----------------|-------------|-------|-----------|--------|--|
| | Min. | Max. | Min. | Max. | |
| Α | 2.16 | 2.41 | 0.085 | 0.095 | |
| b | 0.41 | 0.495 | 0.016 | 0.0195 | |
| b1 | 0.41 | 0.495 | 0.016 | 0.0195 | |
| D | 4.37 | 4.77 | 0.172 | 0.188 | |
| E | 3.61 | 4.01 | 0.142 | 0.158 | |
| e* | 1.27 NOM | | 0.050 NOM | | |
| e [†] | 2.54 NOM | | 0.100 NOM | | |
| F [‡] | | 2.50 | _ | 0.098 | |
| L | 13.00 | 13.97 | 0.512 | 0.550 | |

NOTES:

- * loose product only
- † taped product only
- ‡ leads uncontrolled above seating plane

Controlling dimensions are in millimeters. Approximate dimensions are provided in inches



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